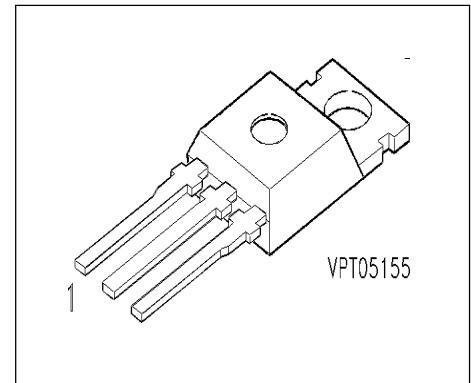


SIPMOS[®] Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated



| Pin 1 | Pin 2 | Pin 3 |
|-------|-------|-------|
| G | D | S |

| Type | V _{DS} | I _D | R _{DS(on)} | Package | Ordering Code |
|--------|-----------------|----------------|---------------------|-----------|-----------------|
| BUZ 12 | 50 V | 42 A | 0.028 Ω | TO-220 AB | C67078-S1331-A2 |

Maximum Ratings

| Parameter | Symbol | Values | Unit |
|---|--------------------------|---------------|------|
| Continuous drain current <i>T_C</i> = 65 °C | <i>I_D</i> | 42 | A |
| Pulsed drain current <i>T_C</i> = 25 °C | <i>I_{Dpuls}</i> | 168 | |
| Avalanche current, limited by <i>T_{jmax}</i> | <i>I_{AR}</i> | 42 | |
| Avalanche energy, periodic limited by <i>T_{jmax}</i> | <i>E_{AR}</i> | 2.5 | mJ |
| Avalanche energy, single pulse <i>I_D</i> = 42 A, <i>V_{DD}</i> = 25 V, <i>R_{GS}</i> = 25 Ω <i>L</i> = 23.2 μH, <i>T_j</i> = 25 °C | <i>E_{AS}</i> | 41 | |
| Gate source voltage | <i>V_{GS}</i> | ± 20 | V |
| Power dissipation <i>T_C</i> = 25 °C | <i>P_{tot}</i> | 125 | W |
| Operating temperature | <i>T_j</i> | -55 ... + 150 | °C |
| Storage temperature | <i>T_{stg}</i> | -55 ... + 150 | |
| Thermal resistance, chip case | <i>R_{thJC}</i> | ≤ 1 | K/W |
| Thermal resistance, chip to ambient | <i>R_{thJA}</i> | ≤ 75 | |
| DIN humidity category, DIN 40 040 | | E | |
| IEC climatic category, DIN IEC 68-1 | | 55 / 150 / 56 | |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|--|---------------|--------|-----------|----------|---------------|
| | | min. | typ. | max. | |
| Static Characteristics | | | | | |
| Drain- source breakdown voltage $V_{GS} = 0\text{ V}, I_D = 0.25\text{ mA}, T_j = 25\text{ }^\circ\text{C}$ | $V_{(BR)DSS}$ | 50 | - | - | V |
| Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$ | $V_{GS(th)}$ | 2.1 | 3 | 4 | |
| Zero gate voltage drain current $V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}, T_j = 25\text{ }^\circ\text{C}$ $V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}, T_j = 125\text{ }^\circ\text{C}$ | I_{DSS} | - | 0.1 10 | 1 100 | μA |
| Gate-source leakage current $V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$ | I_{GSS} | - | 10 | 100 | nA |
| Drain-Source on-resistance $V_{GS} = 10\text{ V}, I_D = 32\text{ A}$ | $R_{DS(on)}$ | - | 0.024 | 0.028 | Ω |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

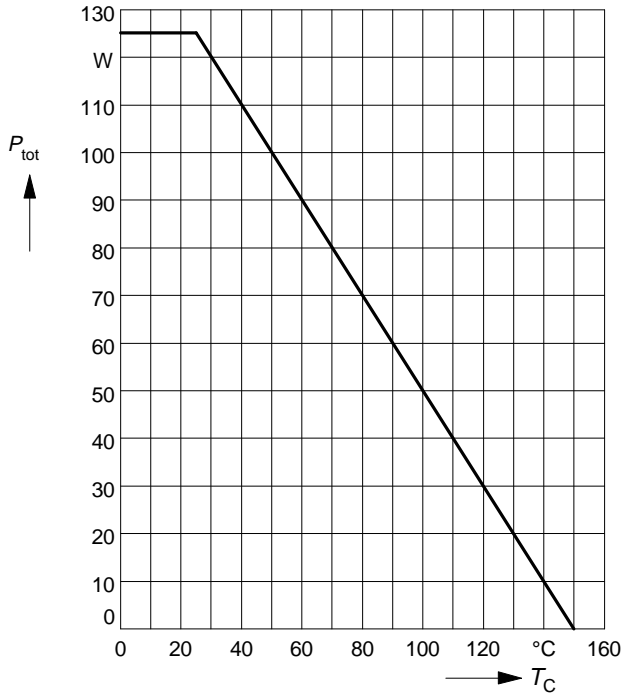
| Parameter | Symbol | Values | | | Unit |
|--|--------------|--------|------|------|------|
| | | min. | typ. | max. | |
| Dynamic Characteristics | | | | | |
| Transconductance $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$, $I_D = 32 \text{ A}$ | g_{fs} | 12 | 23 | - | S |
| Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | C_{iss} | - | 1700 | 2300 | pF |
| Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | C_{oss} | - | 800 | 1200 | |
| Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | C_{rss} | - | 280 | 420 | |
| Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 3 \text{ A}$ $R_{GS} = 50 \Omega$ | $t_{d(on)}$ | - | 35 | 50 | ns |
| Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 3 \text{ A}$ $R_{GS} = 50 \Omega$ | t_r | - | 85 | 130 | |
| Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 3 \text{ A}$ $R_{GS} = 50 \Omega$ | $t_{d(off)}$ | - | 220 | 280 | |
| Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 3 \text{ A}$ $R_{GS} = 50 \Omega$ | t_f | - | 140 | 180 | |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|---|----------|--------|------|------|---------------|
| | | min. | typ. | max. | |
| Reverse Diode | | | | | |
| Inverse diode continuous forward current $T_C = 25^\circ\text{C}$ | I_S | - | - | 42 | A |
| Inverse diode direct current, pulsed $T_C = 25^\circ\text{C}$ | I_{SM} | - | - | 168 | |
| Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = 84\text{ A}$ | V_{SD} | - | 1.8 | 2.2 | V |
| Reverse recovery time $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$ | t_{rr} | - | 80 | - | ns |
| Reverse recovery charge $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$ | Q_{rr} | - | 0.14 | - | μC |

Power dissipation

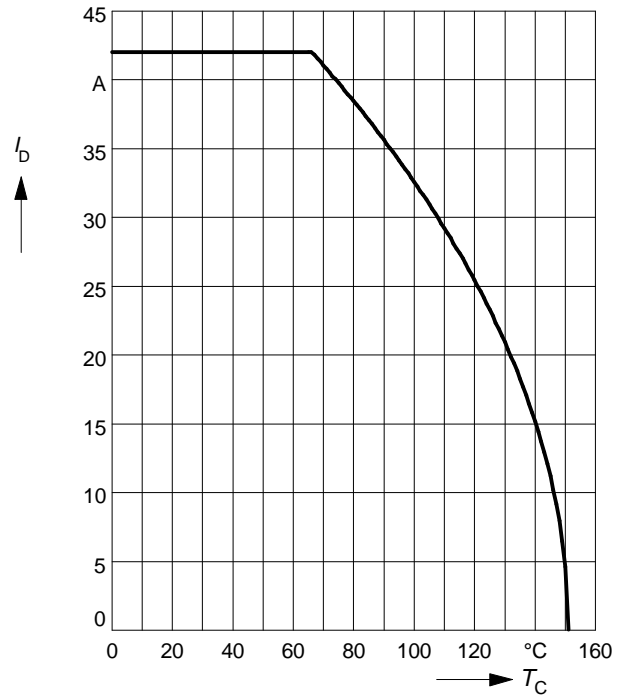
$$P_{\text{tot}} = f(T_C)$$



Drain current

$$I_D = f(T_C)$$

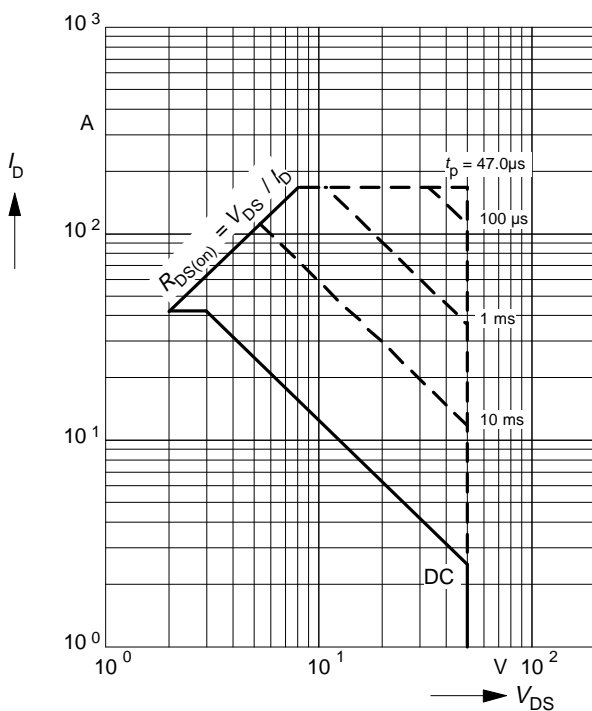
parameter: $V_{GS} \geq 10 \text{ V}$



Safe operating area

$$I_D = f(V_{DS})$$

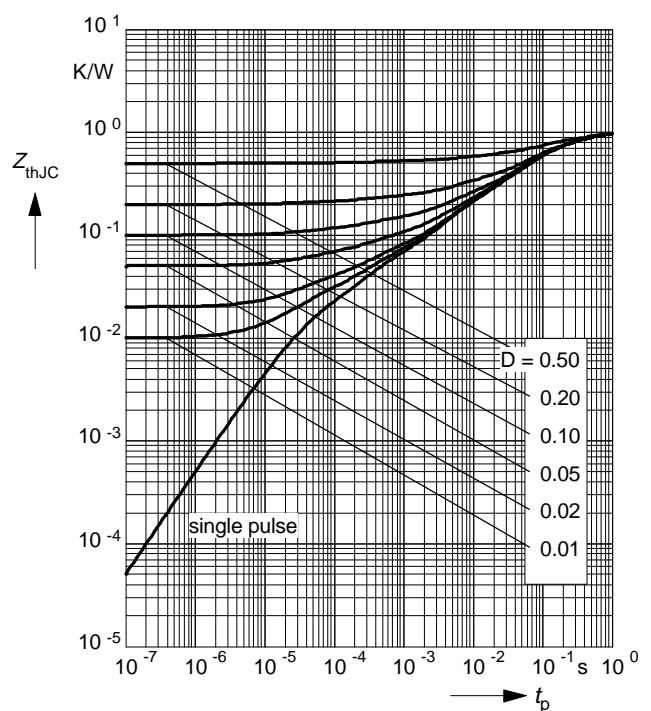
parameter: $D = 0, T_C = 25^\circ\text{C}$



Transient thermal impedance

$$Z_{\text{th JC}} = f(t_p)$$

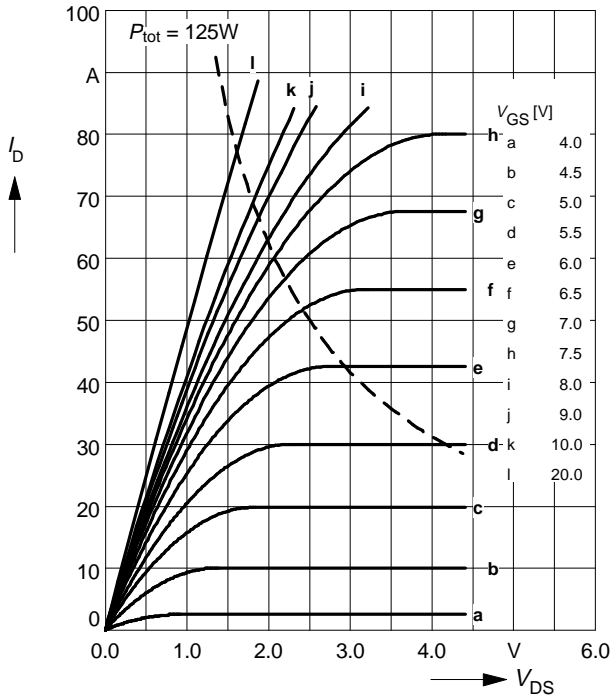
parameter: $D = t_p / T$



Typ. output characteristics

$$I_D = f(V_{DS})$$

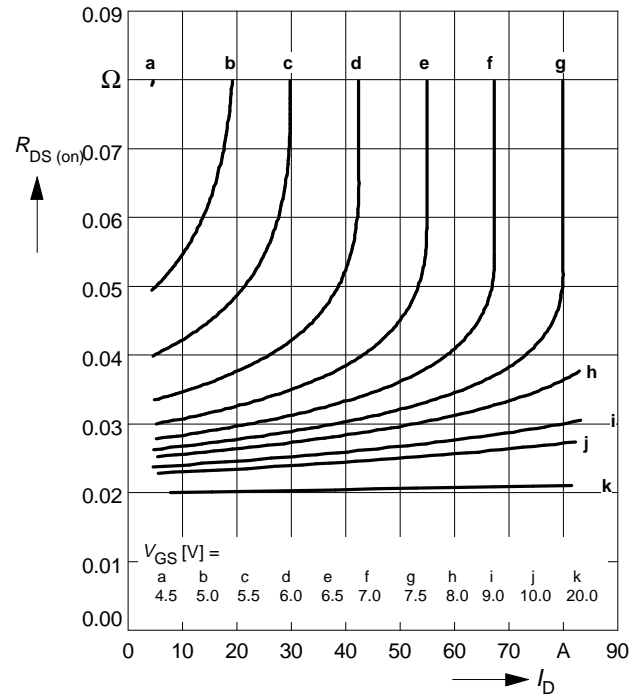
parameter: $t_p = 80 \mu s$



Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

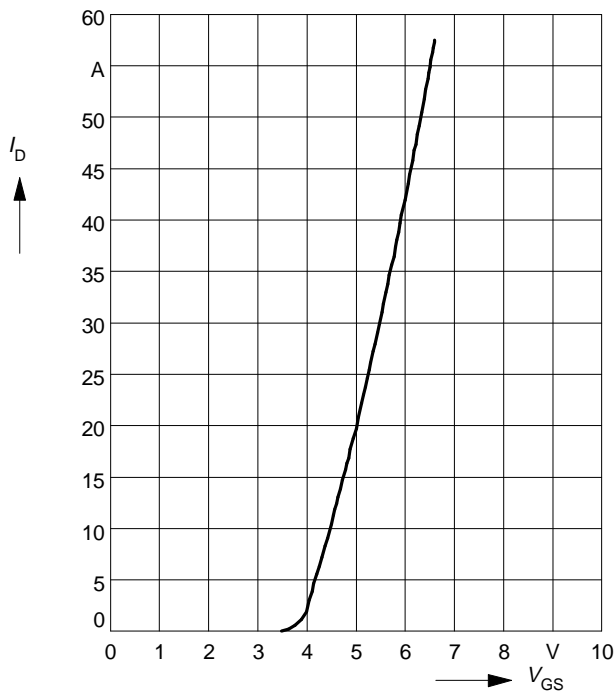
parameter: V_{GS}



Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$

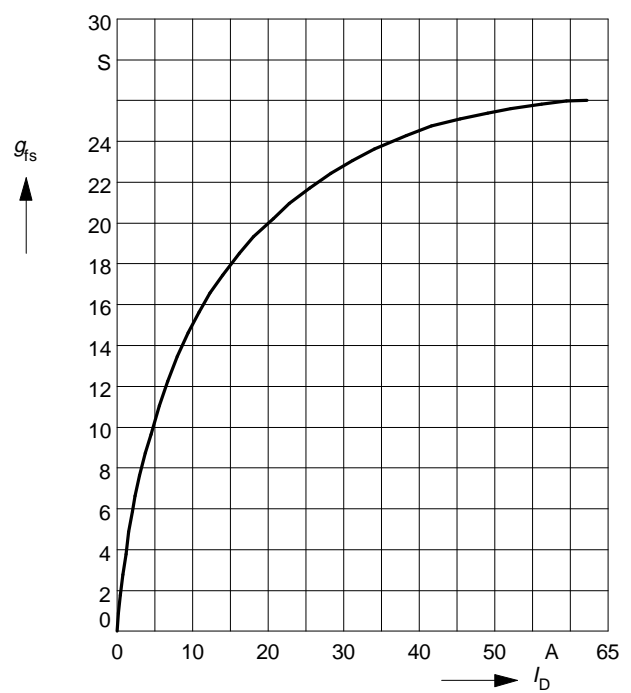
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



Typ. forward transconductance $g_{fs} = f(I_D)$

parameter: $t_p = 80 \mu s$,

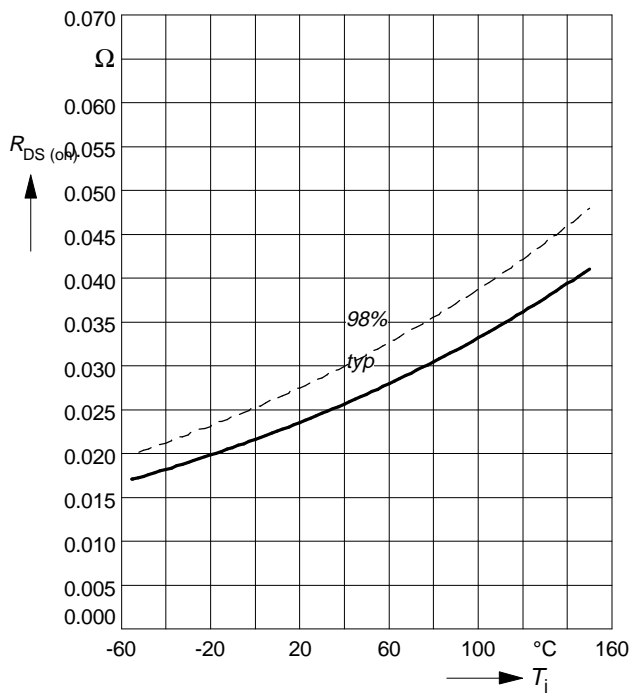
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

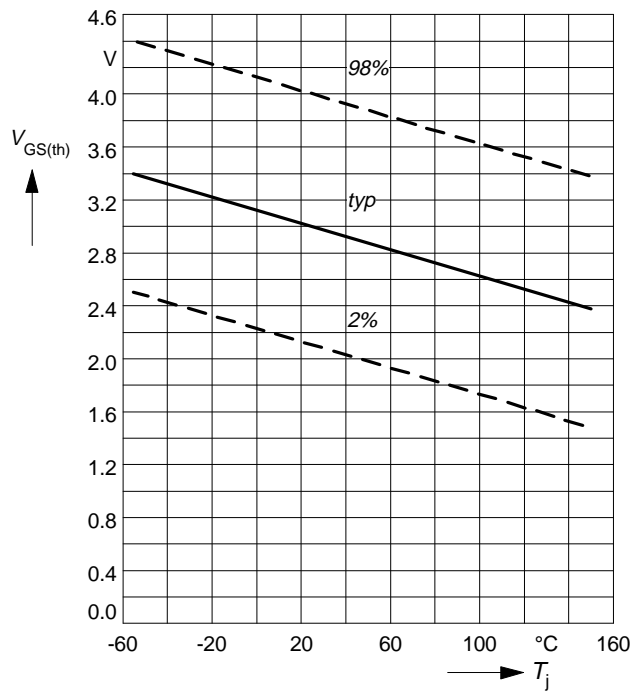
parameter: $I_D = 32\text{ A}$, $V_{GS} = 10\text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

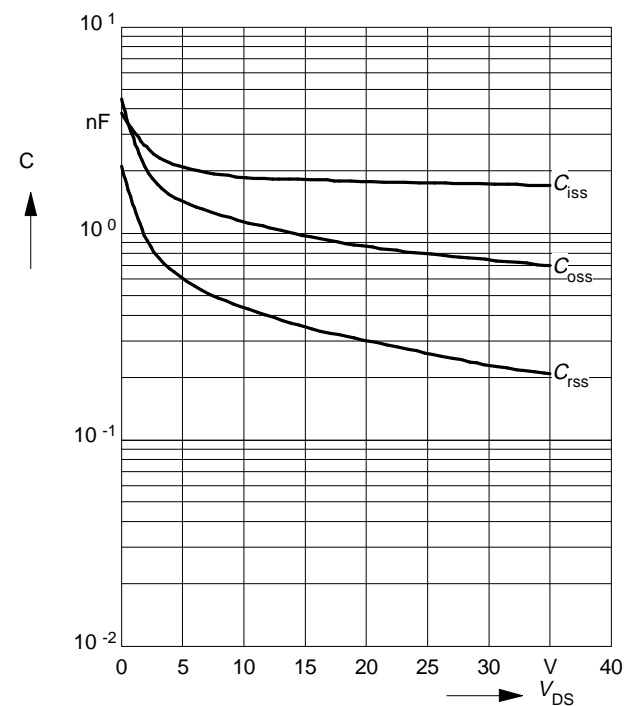
parameter: $V_{GS} = V_{DS}$, $I_D = 1\text{ mA}$



Typ. capacitances

$$C = f(V_{DS})$$

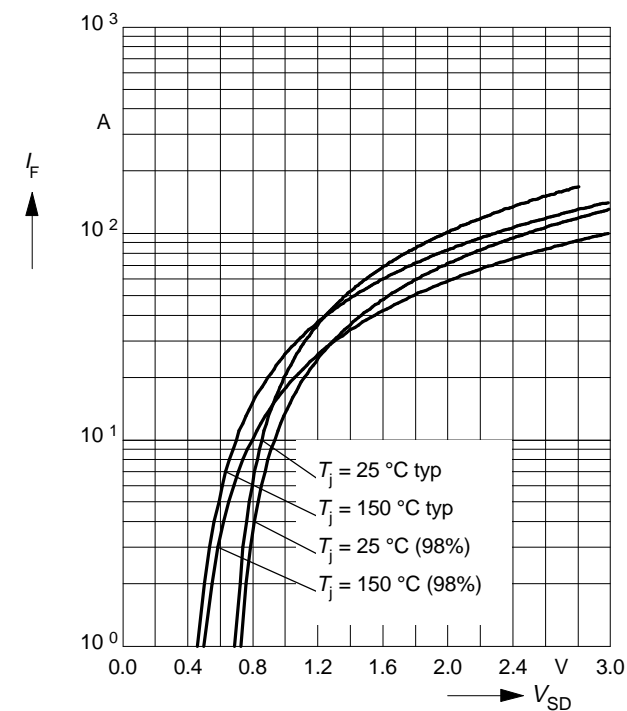
parameter: $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$



Forward characteristics of reverse diode

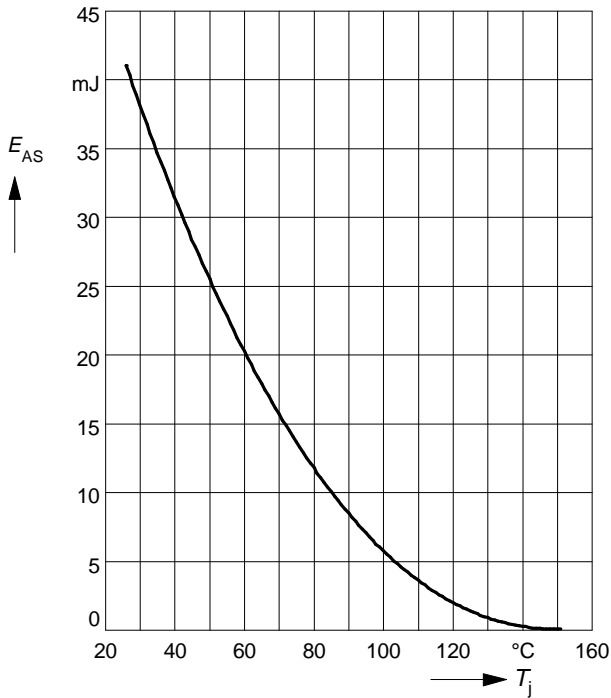
$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80\text{ }\mu\text{s}$



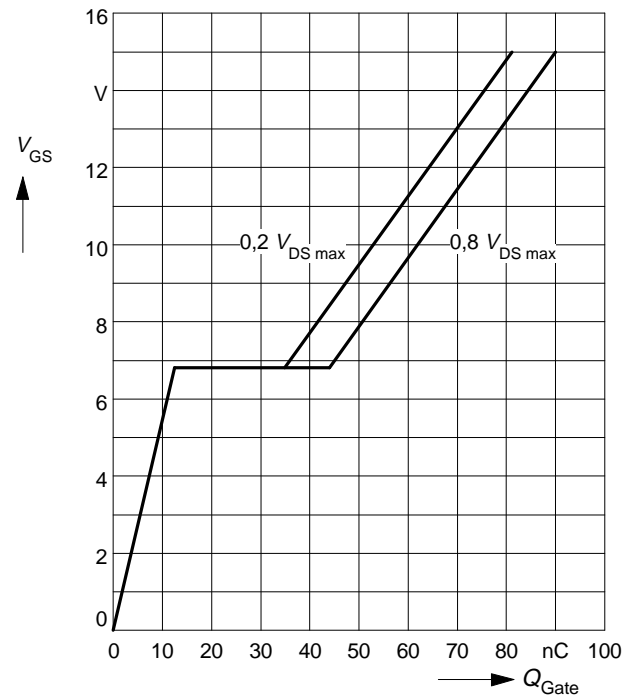
Avalanche energy $E_{AS} = f(T_j)$

parameter: $I_D = 42\text{ A}$, $V_{DD} = 25\text{ V}$
 $R_{GS} = 25\ \Omega$, $L = 23.2\ \mu\text{H}$



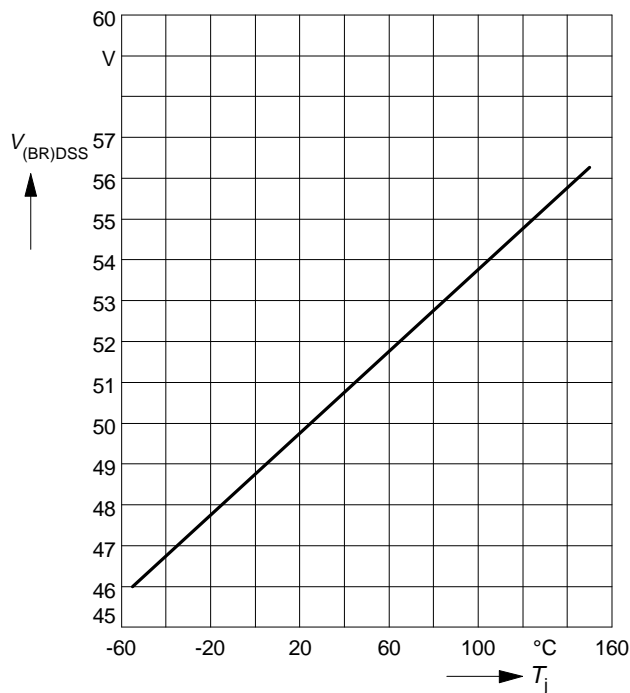
Typ. gate charge $V_{GS} = f(Q_{Gate})$

parameter: $I_{D\text{ puls}} = 63\text{ A}$



Drain-source breakdown voltage $V_{(BR)DSS} = f(T_j)$

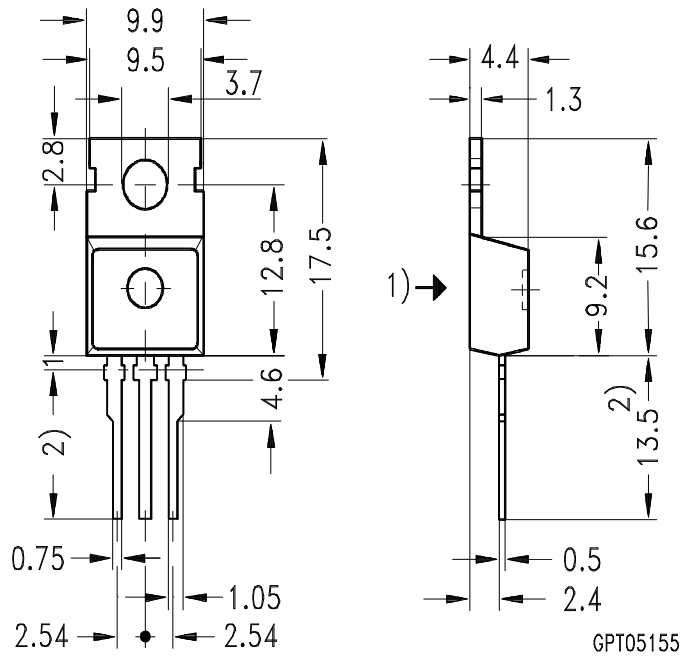
$V_{(BR)DSS} = f(T_j)$



Package Outlines

TO-220 AB

Dimension in mm



GPT05155

- 1) punch direction, burr max. 0.04
- 2) dip finning
- 3) max. 14.5 by dip finning press burr max. 0.05



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